CJD112 NPN CJD117 PNP

SURFACE MOUNT SILICON COMPLEMENTARY POWER DARLINGTON TRANSISTORS





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DESCRIPTION:

The CENTRAL SEMICONDUCTOR CJD112 and CJD117 are complementary silicon power Darlington transistors manufactured in a surface mount package designed for low speed switching and amplifier applications.

MARKING: FULL PART NUMBER

MAXIMUM RATINGS: (T _C =25°C unless otherwi	ise noted)		
	SYMBOL		UNITS
Collector-Base Voltage	V_{CBO}	100	V
Collector-Emitter Voltage	VCEO	100	V
Emitter-Base Voltage	V_{EBO}	5.0	V
Continuous Collector Current	IC	2.0	Α
Peak Collector Current	I _{CM}	4.0	Α
Continuous Base Current	I_{B}	50	mA
Power Dissipation	P_{D}	20	W
Power Dissipation (T _A =25°C)	P_{D}	1.75	W
Operating and Storage Junction Temperature	T _J , T _{stg}	-65 to +150	°C
Thermal Resistance	ΘJC	6.25	°C/W
Thermal Resistance	$\Theta_{\sf JA}$	71.4	°C/W
ELECTRICAL CHARACTERISTICS: (T _C =25°C	unless otherwise no	oted)	LINUTO

	. CHARACTERISTICS: (1 _C =25°C unles:			
SYMBOL	DL TEST CONDITIONS MIN		MAX	UNITS
ICEO	V _{CE} =50V		20	μΑ
ICEV	$V_{CE}=80V$, $V_{BE(off)}=1.5V$		10	μΑ
ICEV	V _{CE} =80V, V _{BE(off)} =1.5V, T _C =125°C		500	μΑ
I _{CBO}	V _{CB} =80V		10	μΑ
ICBO	V _{CB} =100V		20	μΑ
I _{EBO}	V _{EB} =5.0V		2.0	mA
BV _{CEO}	I _C =30mA		100	V
V _{CE} (SAT)	I _C =2.0A, I _B =8.0mA		2.0	V
VCE(SAT)	I _C =4.0A, I _B =40mA		3.0	V
V _{BE} (SAT)	I _C =4.0A, I _B =40mA		4.0	V
V _{BE} (ON)	$V_{CE}=3.0V, I_{C}=2.0A$		2.8	V
hFE	$V_{CE}=3.0V, I_{C}=0.5A$	500		
hFE	$V_{CE}=3.0V, I_{C}=2.0A$	1000	12000	
h _{FE}	$V_{CE} = 3.0V, I_{C} = 4.0A$	200		
f _T	V _{CE} =10V, I _C =750mA, f=1.0MHz	25		MHz
C _{ob}	V _{CB} =10V, I _E =0, f=0.1MHz (CJD112)		100	pF
C_{ob}	V_{CB} =10V, I_E =0, f=0.1MHz (CJD117)		200	pF

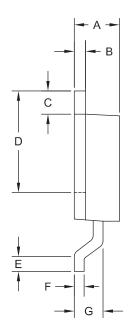
R3 (21-January 2013)

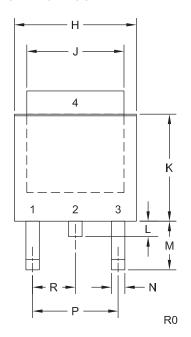
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DPAK CASE - MECHANICAL OUTLINE





LEAD CODE:

- 1) Base
- 2) Collector
- 3) Emitter 4) Collector

MARKING: **FULL PART NUMBER**

DIMENSIONS							
	INCHES		MILLIMETERS				
SYMBOL	MIN	MAX	MIN	MAX			
Α	0.083	0.108	2.10	2.75			
В	0.016	0.032	0.40	0.81			
С	0.035	0.063	0.89	1.60			
D	0.203	0.228	5.15	5.79			
E	0.020	-	0.51	-			
F	0.018	0.024	0.45	0.60			
G	0.051	0.071	1.30	1.80			
Н	0.248	0.268	6.30	6.81			
J	0.197	0.217	5.00	5.50			
K	0.209	0.245	5.30	6.22			
L	0.025	0.040	0.64	1.02			
M	0.090	0.115	2.30	2.91			
N	0.012	0.045	0.30	1.14			
Р	0.180		4.60				
R	0.090		2.30				
DPAK (REV: R0)							

R3 (21-January 2013)

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CONTACT US

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